

Features

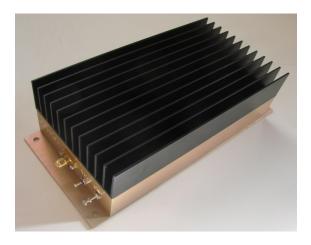
- Frequency Range: 135-175MHz (min)
- Gain: 38.5dB (typ.)
- P_{3dB}: >+43.0dBm
- P_{sat}: >+44.5dBm
- DCpower: 12V (nominal), 9-15V OK
- SMA-Female connectorized
- Typ. for Mobile Radio, HAM Radio, etc

Description

HD29985 is a 20Watt output (min. $@P_{3dB})$ RF PowerAmplifier; within frequencies of 135 to 175MHz; operating from a single 12VDC power supply. Also usable within 130-180MHz, 9-

130 – 180 MHz 20-28W RF Power Amplifier

15VDC (not recommended). With proper (active) cooling is capable of **28Watt RFpower out** (@P_{sat}), under *special* (non-*standard*) warranty.



Page 1

Electrical Specifications @ +25°C, Z_{in}=Z_{out}=50Ohm, V_{supply} = +12VDC IMPORTANT: MUST USE ACTIVE COOLING IF CASE TEMP. EXCEEDS 65°C or to ACHIEVE MAX. RFpower

IMPORTANT: MUST USE ACTIVE COOLING IF CASE TEMP. EXCEEDS 65°C or to ACHIEVE MAX. RFpowe Output over 16W upto 28W (over +42dBm upto +44.5dBm).

Parameter	Unit	Minimum	Typical	Maximum
Frequency Range	MHz	135 [130]		175 [180]
Small Signal Gain	dB	37.6	38.5	40.4
Output Power - 3dB gain compr. (P_{3dB})	dBm	42.5	+43	
Output Power - saturated (P _{sat})	dBm	+44.0	+44.5	
Reverse Isolation (S12) @155MHz	dB		-54.0	-51
VSWR - Input (S11)	ratio:1	1.1 @140MHz	1.5 @155MHz	2.3 @175MHz
VSWR - Output (S22)	(unitless)	2.0 @148MHz	2.2	2.6 @135MHz
VSWR - Load Tolerance (non-destructive)	ratio:1			18:1
Efficiency @155MHz & Pout in dBm	%	<26 @P _{out} <+40	34 @P _{out} +42	45 @P _{out} +44
DCpower Supply - voltage (unipolar, positive)	V	9 not	12	15 not
		recommended		recommended

HD Communications Corp. 332-C Dante Court, Holbrook, NY 11741 Tel: (631) 588-3877 Fax: (631) 648-0518 Email: sales@hdcom.com

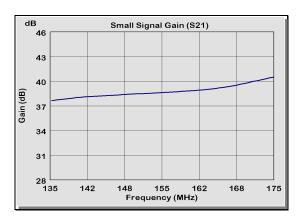


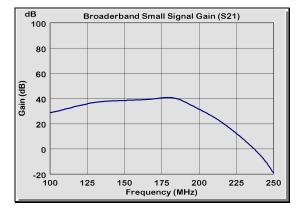
130 – 180 MHz 20-28W RF Power Amplifier

DCpower Supply - current: quiesc. (no RF)	А	1.8	2.0	
$@P_{out} = +40dBm$	А		3.2	3.9
Size (incl. all hardware & heatsink [standard])	Inch	7.00 (L) x 3.25 (W) x 2.00 (H)		
Weight (incl. all hardware & heatsink [standard])	Oz	24		

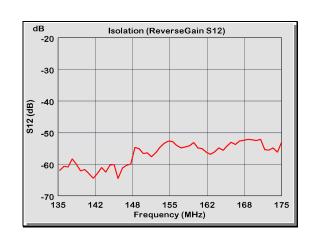
Typical Performance @ +25°C

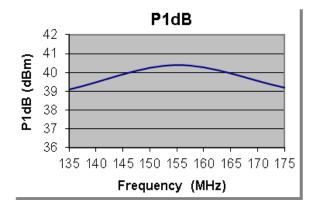
download)





(Power & S-parameters also available for

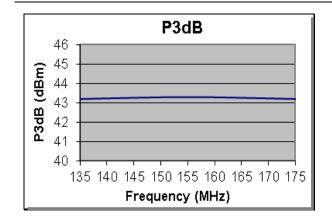


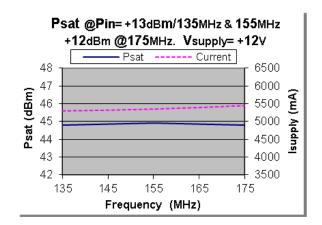


Page 2



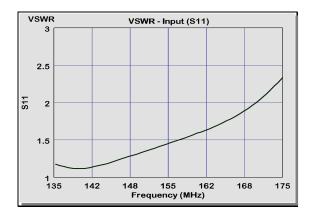




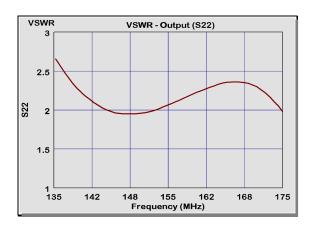


Typical Performance @ +25°C

download)



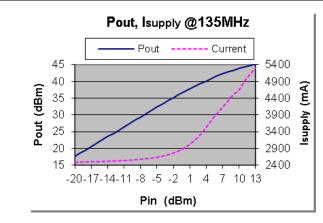
(Power & S-parameters also available for

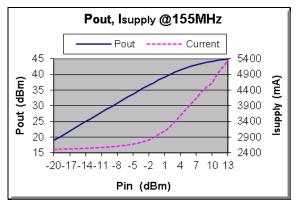


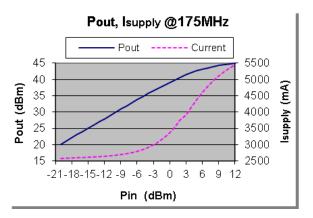


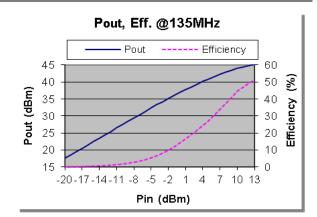
130 – 180 MHz 20-28W RF Power Amplifier

Page 4





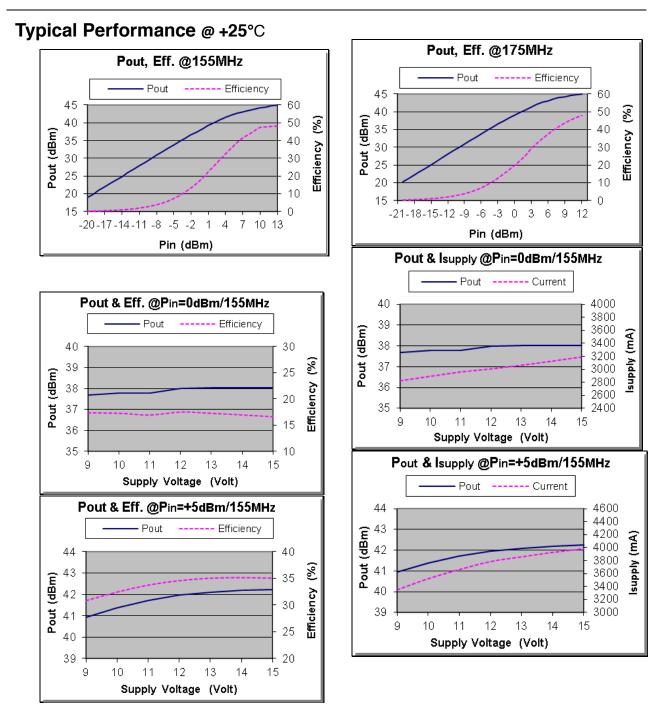




HD Communications Corp. 332-C Dante Court, Holbrook, NY 11741 Tel: (631) 588-3877 Fax: (631) 648-0518 Email: sales@hdcom.com



130 – 180 MHz 20-28W RF Power Amplifier





130 – 180 MHz 20-28W **RF** Power Amplifier

RFBay Inc. - model "HPA155" S12 S22 dB <u>S11</u> <u>S21</u> Absolute Maximum Ratings 50 40 30 **Parameter** Absolute Maximum 20 10 0 S-params (dB) **RF Input Power** +15dBm -10 -20 -30 Supply Voltage +16V -40 **Operating Temperature** -30 °C to +65 °C -50 -60 Storage Temperature -55 °C to +100 °C Storage remperature -55 °C to +100 °C -70 135 139 143 147 151 155 159 163 167 171 175 The above parameters are independently guaranteed and are @ icase <23 °C, unless otherwise specified</td>

APPLICATION NOTES (reliability):

• Thermal:

Specifications shown above as graphs, are at room temperature (23-25°C i.e. in a controlled environment), per international standard. If Amplifier's temperature is let rise significantly (e.g. towards max. 65-70°C) in customer's use, DCpower (supply) current may rise and stabilize at approx. 200-450mA higher values vs. shown in graphs, especially if at the same time RF PowerOut is driven beyond approx. 12Watt (contributing to selfheating, besides ambient temperature) - which is normal. Such increase in DCsupply current due to higher than standard ambient temperature, is less pronounced at low RF PowerOut; at below 1Watt it may add less than 90mA vs. current @25°C. Amplifier is designed to operate normal at ANY temperature or RF PowerOut within specs, this notice is only a recommendation to expect higher DCcurrent if user allows heat build-up far above standard 25°C.

Stock Heatsink is removable & upgradeable by the user, additionally Mountplate (opposite of heatsink) is strongly recommended to mount on a surface conducting heat away (e.g. mass of metal); some customers use active cooling such as fans (for extreme environment, even liquid cooling is an option), however be careful to not generate ElectroStatic Fields harmful for RF/Microwave devices. Use of inadequate Heatsink or HeatSpreader instead of stock, or inappropriate thermal-interface-material (TIM, i.e. grease, paste, semi-solids) voids warranty; HD Communications Corp. reserves the right to determine if a unit submitted for warranty service had been thermally abused. The key to reliability, is not only to minimize temperature rise, but also avoid repetitive thermal gradient (shock) due to cold-hot-cold cycling; these Amplifiers are meant for Commercial (rather than Mission-Critical) Mobile communications; in particular in Base & Fixed station applications with long-term continuous transmission and a higher On-Off frequency, please consider derating, redundancy system, maintenance schedule, or otherwise assure reliability.

Oscillation & Load VSWR:

This amplifier's rugged design can withstand Load VSWR mismatch upto 18:1 (no degradation/destruction), guaranteed stable (no parasitic self-oscillation) for Pout<30Watt & Load VSWR under 3:1. If oscillation is observed, check if Load & Source impedances $Z_L = Z_S = 50$ Ohm; adding DCpower decoupling ceramic + electrolytic capacitors (in parallel, closest possible to amplifier & minimal parasitic inductance to Ground) may help but not necessary, because already present internally. • ESD:

HD Communications Corp. 332-C Dante Court, Holbrook, NY 11741 Tel: (631) 588-3877 Fax: (631) 648-0518 Email: sales@hdcom.com

Page 6



130 – 180 MHz 20-28W RF Power Amplifier

Sensitive to ESD voltages to approx. 1KiloVolt - as typical for RF/Microwave amplifiers, appropriate ESD precaution is required.

Mounting & DCpower connection:

Avoid excessive or torque (twisting) force onto DC terminals

Outline (compact version)

Also available as a standalone higher-resolution *3Dmodel (MCADsolid)* & *2Ddrawing* - see "Notes" on compact drawing (below):

